

N-channel 1500 V, 1.6 Ω typ.,7 A MDmesh[™] K5 Power MOSFET in a TO-247 package

Datasheet - production data

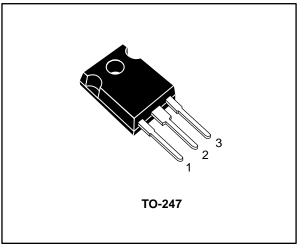
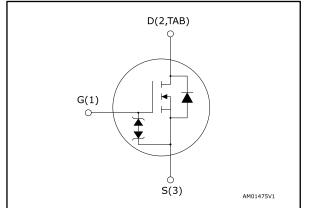


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	ID	Ртот
STW12N150K5	1500 V	1.9 Ω	7 A	250 W

- Industry's lowest R_{DS(on)} * area
- Industry's best figure of merit (FoM)
- Ultra low gate charge
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

This very high voltage N-channel Power MOSFET is designed using MDmesh[™] K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

Order code	Marking	Package	Packing
STW12N150K5	12N150K5	TO-247	Tube

DocID027833 Rev 3

This is information on a product in full production.

Contents

Contents

1	Electric	cal ratings	3
2	Electric	cal characteristics	4
	2.1	Electrical characteristics (curves)	6
3	Test cir	rcuits	9
4	Packag	e information	10
	4.1	TO-247 package information	10
5	Revisio	on history	12



1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter Value		Unit
V _{GS}	Gate-source voltage	± 30	V
Ι _D	Drain current at T _C = 25 °C	7	А
ID	Drain current at T _C = 100 °C	4	А
I _{DM} ⁽¹⁾	Drain current (pulsed)	28	А
P _{TOT}	Total dissipation at $T_c = 25 \text{ °C}$	250	W
dv/dt ⁽²⁾	Peak diode recovery voltage slope	4.5	V/ns
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	50	V/ns
Tj	Operating junction temperature	- 55 to 150	°C
T _{stg}	Storage temperature	- 55 10 150	C

Notes:

 $^{(1)}\mbox{Pulse}$ width limited by safe operating area

 $^{(2)}I_{SD} \leq$ 7 A, di/dt \leq 100 A/µs, V_{Peak} \leq V_{(BR)DSS}

⁽³⁾V_{DS} ≤ 1200 V

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	0.5	°C/W
R _{thj-amb}	Thermal resistance junction-amb	50	°C/W

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Max current during repetitive or single pulse avalanche	2	А
E _{AS}	Single pulse avalanche energy	900	mJ



2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

Т	able	5: O	n/of	f states	
		_			

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	V_{GS} = 0 V, I_D = 1 mA	1500			V
I _{DSS} Zero gate voltage drain current	$V_{GS} = 0 V, V_{DS} = 1500 V$			1	μA	
	0 0	V _{GS} = 0 V, V _{DS} = 1500 V, Tc=125 °C			50	μA
I _{GSS}	Gate body leakage current	$V_{DS} = 0, V_{GS} = \pm 20 V$			±10	μA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 100 \ \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on- resistance	V_{GS} = 10 V, I _D = 3.5 A		1.6	1.9	Ω

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	1360	-	pF
Coss	Output capacitance	$V_{GS} = 0 V, V_{DS} = 100 V,$	-	80	-	pF
C _{rss}	Reverse transfer capacitance	f = 1MHz	-	0.7	-	pF
C _{o(tr)} ⁽¹⁾	Equivalent capacitance time related	$V_{DS} = 0 V$ to 1200 V, $V_{GS} = 0 V$	-	82	-	pF
C _{o(er)} ⁽²⁾	Equivalent capacitance energy related		-	32	-	pF
R _G	Intrinsic gate resistance	$f = 1 \text{ MHz}, I_D = 0 \text{ A}$	-	3	-	Ω
Qg	Total gate charge	$V_{DD} = 1200V, I_D = 7 A$	-	47	-	nC
Q _{gs}	Gate-source charge	V _{GS} = 10 V	-	8	-	nC
Q_{gd}	Gate-drain charge	(see Figure 16: "Gate charge test circuit")	-	32	-	nC

Table 6: Dynamic

Notes:

⁽¹⁾Time related is defined as a constant equivalent capacitance giving the same charging time as Coss when VDS increases from 0 to 80% VDSS.

 $^{(2)}$ Energy related is defined as a constant equivalent capacitance giving the same stored energy as Coss when VDS increases from 0 to 80% VDSS.



Electrical characteristics

_	Table 7: Switching times									
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit				
t _{d(on)}	Turn-on delay time	V_{DD} = 750 V, I_D = 3.5 A, R_G = 4.7 Ω V_{GS} = 10 V (see Figure 18: "Unclamped inductive load test circuit")	-	25	-	ns				
tr	Rise time		-	8	-	ns				
t _{d(off)}	Turn-off delay time		-	90	-	ns				
t _f	Fall time		-	37	-	ns				

Table 8: Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		7	А
I _{SDM}	Source-drain current (pulsed)		-		28	А
V _{SD} ⁽¹⁾	Forward on voltage	$I_{SD} = 7 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$	-		1.5	V
t _{rr}	Reverse recovery time	$I_{SD} = 7 \text{ A}, V_{DD} = 60 \text{ V}$ di/dt = 100 A/µs, (see Figure 17: "Test circuit for	-	302		ns
Qrr	Reverse recovery charge		-	3.71		μC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times")	-	24.6		А
t _{rr}	Reverse recovery time	$I_{SD} = 7 \text{ A}, V_{DD} = 60 \text{ V}$ di/dt = 100 A/µs,	-	432		ns
Qrr	Reverse recovery charge	Tj = 150 °C (see Figure 17: "Test circuit for	-	4.71		μC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times")	-	21.8		А

Notes:

 $^{(1)}$ Pulsed: pulse duration = 300µs, duty cycle 1.5%

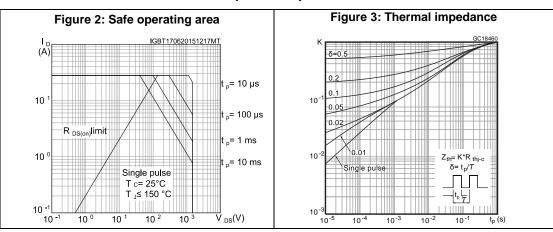
Table 9: Gate-source Zener diode

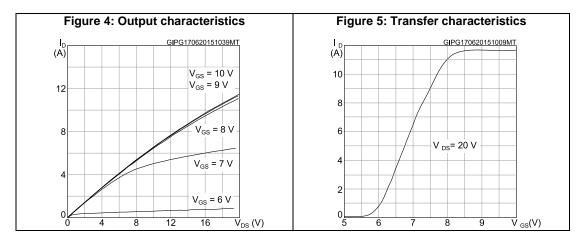
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V(BR)GSO	Gate-source breakdown voltage	$I_{GS} = \pm 1 \text{ mA}, I_D = 0 \text{ A}$	30	-		V

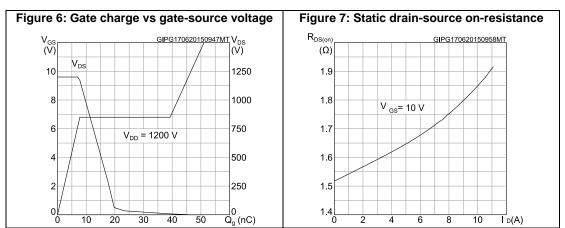
The built-in back-to-back Zener diodes have been specifically designed to enhance the ESD capability of the device. The Zener voltage is appropriate for efficient and cost-effective intervention to protect the device integrity. These integrated Zener diodes thus eliminate the need for external components.



2.1 Electrical characteristics (curves)

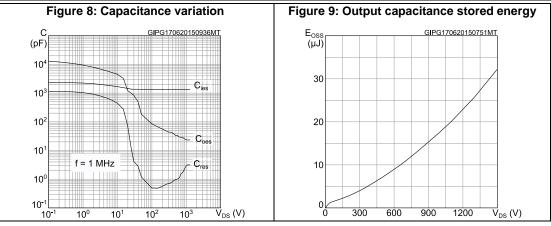


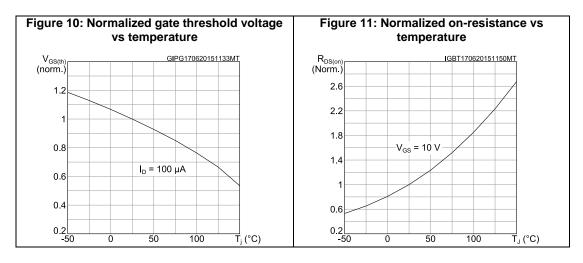


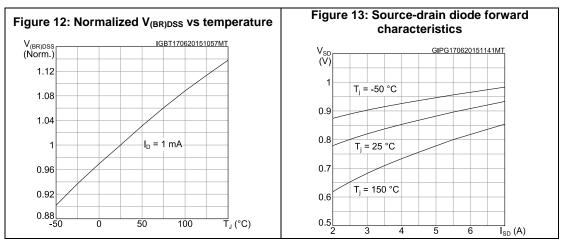




Electrical characteristics



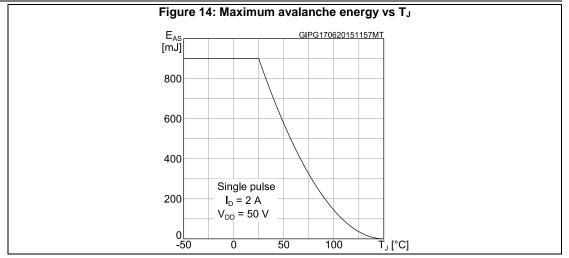




57

Electrical characteristics

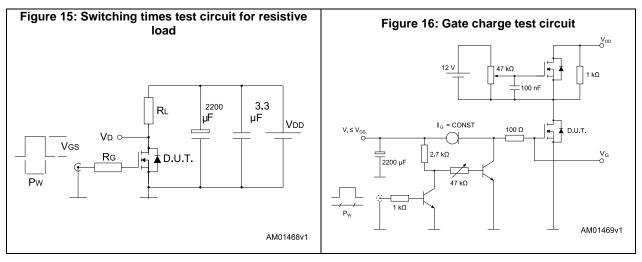
STW12N150K5

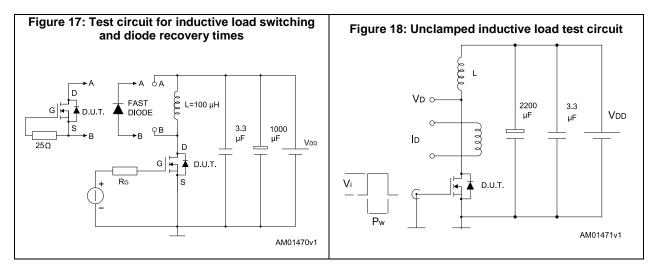


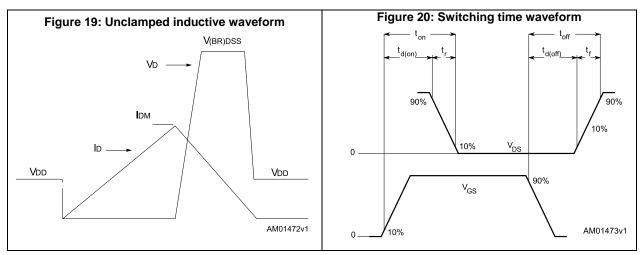


57

3 Test circuits







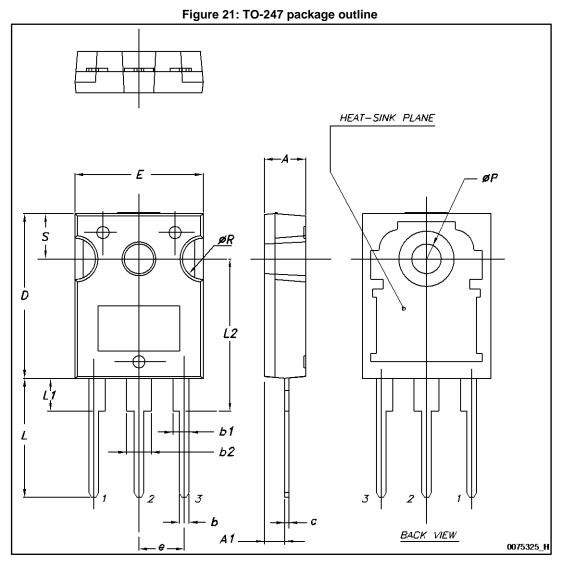
DocID027833 Rev 3

9/13

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 TO-247 package information



DocID027833 Rev 3

57

Package information

Table 10: TO-247 package mechanical data				
Dim.	mm.			
	Min.	Тур.	Max.	
A	4.85		5.15	
A1	2.20		2.60	
b	1.0		1.40	
b1	2.0		2.40	
b2	3.0		3.40	
С	0.40		0.80	
D	19.85		20.15	
E	15.45		15.75	
е	5.30	5.45	5.60	
L	14.20		14.80	
L1	3.70		4.30	
L2		18.50		
ØP	3.55		3.65	
ØR	4.50		5.50	
S	5.30	5.50	5.70	



5 Revision history

Table 11: Document revision history

Date	Revision	Changes	
11-May-2015	1	First release.	
30-Jun-2015	2	Updated title and features in cover page. Updated Section 4: "Electrical ratings", Section 5: "Electrical characteristics". Added Section 5.1: "Electrical characteristics (curves)". Minor text changes.	
07-Jul-2015	3	Updated Section 5.1: "Electrical characteristics (curves)". Minor text changes.	



IMPORTANT NOTICE – PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2015 STMicroelectronics - All rights reserved



X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by STMicroelectronics manufacturer:

Other Similar products are found below :

614233C 648584F IRFD120 JANTX2N5237 FCA20N60_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D TPCC8103,L1Q(CM MIC4420CM-TR VN1206L SBVS138LT1G 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C BUK954R8-60E DMN3404LQ-7 NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911 DMN2080UCB4-7 TK10A80W,S4X(S SSM6P69NU,LF DMP22D4UFO-7B